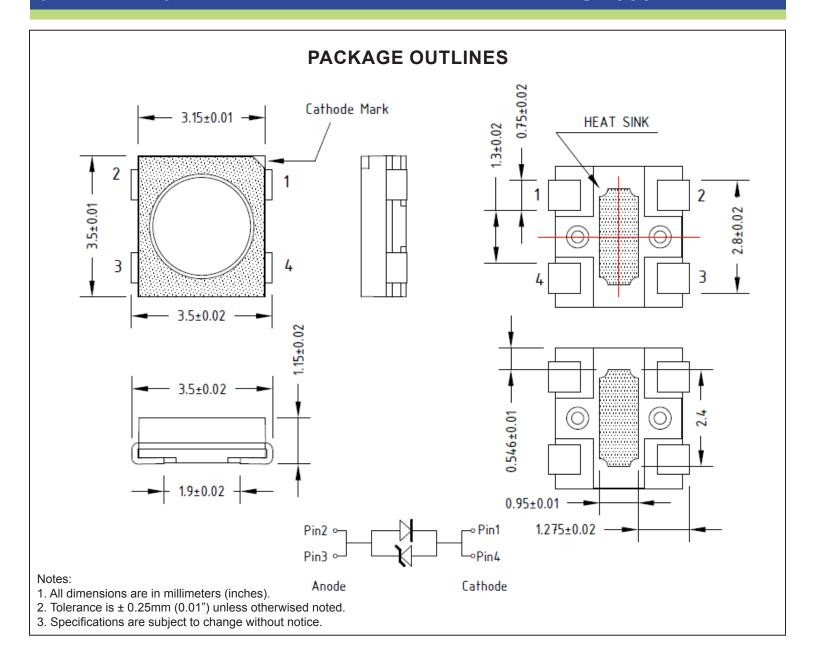


SPECIFICATION

CSH3537NW2ZC-4



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSH3537NW2ZC-4	InGaN	White	Yellow	120°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	180	mA	
ESD Threshold (HBM)	-	4000	V	
LED Junction Temperature	-	115	°C	
Operating Temperature Range	Тор	-30~+100	°C	
Storage Temperature Range	Тѕтс	-40~+100	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lFP	200	mA	
Soldering Temperature	TsoL	Max 265°C for 10 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Darameter	Symbol	Toot Condition	Value			Lloit
Parameter		Test Condition	Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 150mA	35	38	ı	lm
Forward Voltage	VF	IF = 150mA	1	3.2	3.8	V
Viewing Angle at 50% Iv	201/2	IF = 150mA	-	120	-	Deg
Chromaticity Coordinates	Х	IF = 150mA	-	0.31	1	-
Chromaticity Coordinates	Y		-	0.32	1	-

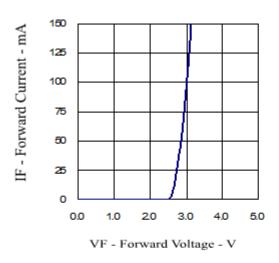
^{*}Tolerance of viewing angle: -10 / +5 deg.



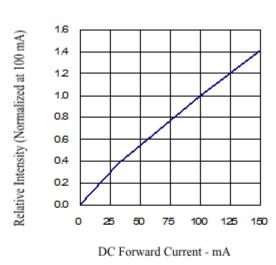


OPTICAL CHARACTERISTIC CURVES

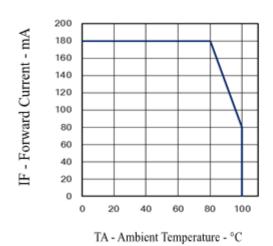
Forward Current vs. Forward Voltage



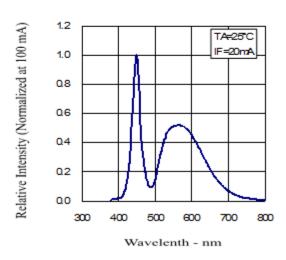
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



Relative Intensity vs. Wavelength

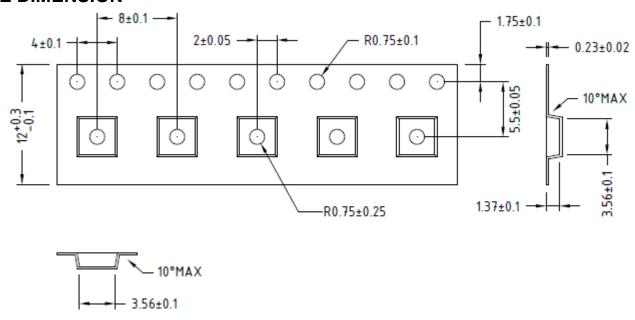




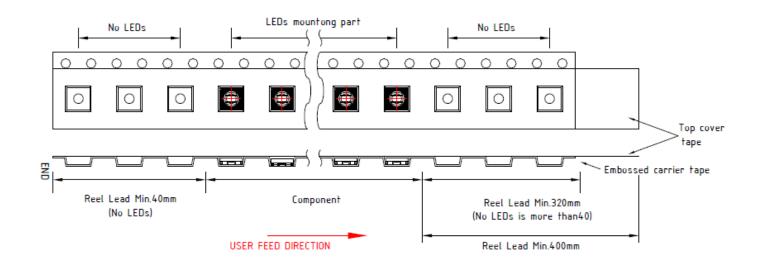


PACKAGING SPECIFICATION

TAPE DIMENSION



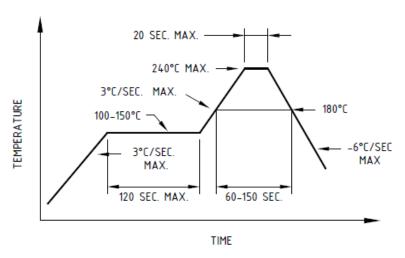
TAPE LEADER AND TRAILER DIMENSION



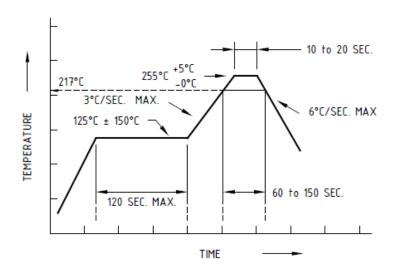




SOLDERING CONDITIONS



Recommended reflow soldering profile



Recommended Pb-free reflow soldering profile

- Repairing should not be done after the LEDs have been soldered. When repairing is
 unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand
 whether the Characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

